



ON Semiconductor®

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2SK932

N-Channel JFET 15V, 5 to 24mA, 50mS, CP

Applications

- AM tuner RF amplifier, low-noise amplifier

Features

- Adoption of FBET process
- Large $|y_{fs}|$
- Small Ciss
- Ultralow noise figure
- Ultrasmall-sized package permitting 2SK932-applied sets to be made smaller and slimmer

Specifications

Absolute Maximum Ratings at $T_a=25^\circ\text{C}$

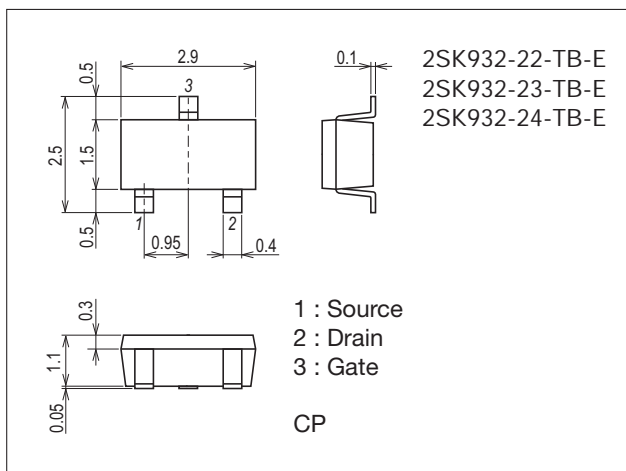
Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DSX}		15	V
Gate-to-Drain Voltage	V_{GDS}		-15	V
Gate Current	I_G		10	mA
Drain Current	I_D		50	mA
Allowable Power Dissipation	P_D		200	mW
Junction Temperature	T_j		150	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55 to +150	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Package Dimensions

unit : mm (typ)

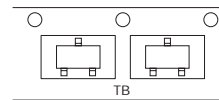
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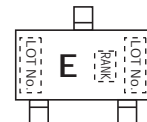
Product & Package Information

- Package : CP
- JEITA, JEDEC : SC-59, TO-236, SOT-23, TO-236AB
- Minimum Packing Quantity : 3,000 pcs./reel

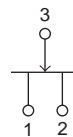
Packing Type: TB



Marking



Electrical Connection



Electrical Characteristics at Ta=25°C

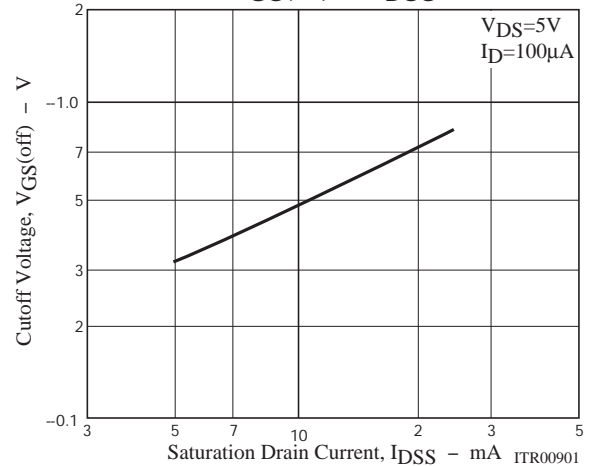
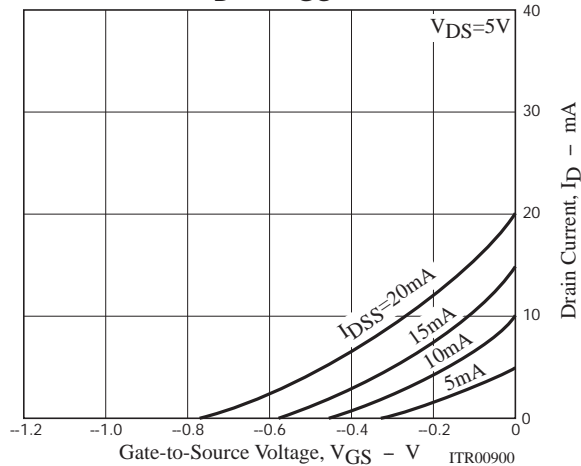
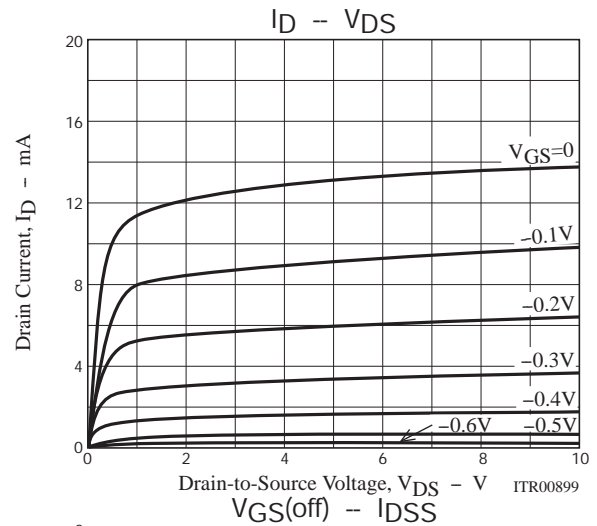
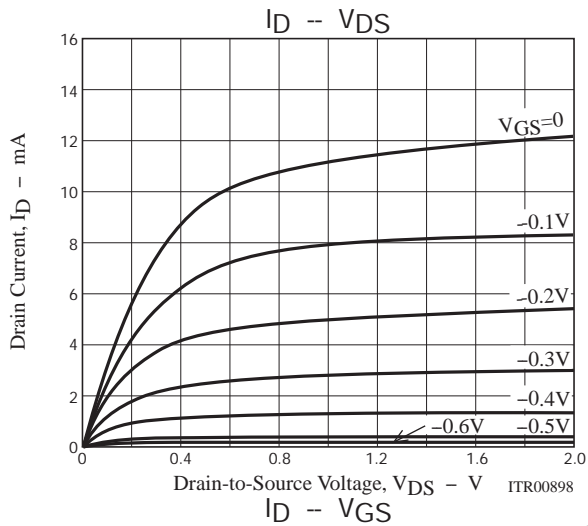
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Gate-to-Drain Breakdown Voltage	V(BR)GDS	I _G =-10μA, V _{DS} =0V	-15			V
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} =-10V, V _{DS} =0V			-1.0	nA
Zero-Gate Voltage Drain Current	I _{DSS}	V _{DS} =5V, V _{GS} =0V	5.0*		24.0*	mA
Cutoff Voltage	V _{GS(off)}	V _{DS} =5V, I _D =100μA	-0.2	-0.6	-1.4	V
Forward Transfer Admittance	y _{fs}	V _{DS} =5V, V _{GS} =0V, f=1kHz	25	50		mS
Input Capacitance	C _{iss}	V _{DS} =5V, V _{GS} =0V, f=1MHz		10		pF
Reverse Transfer Capacitance	C _{rss}			3.0		pF
Noise Figure	NF	V _{DS} =5V, R _G =1kΩ, I _D =1mA, f=1kHz		1.5		dB

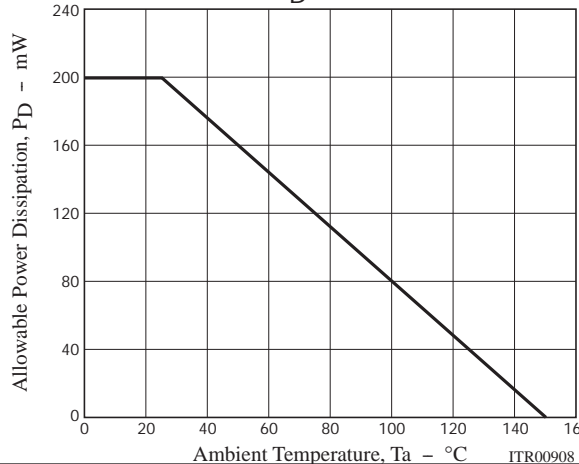
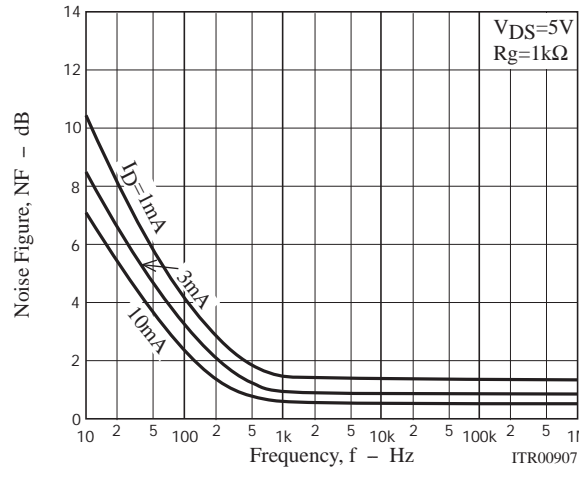
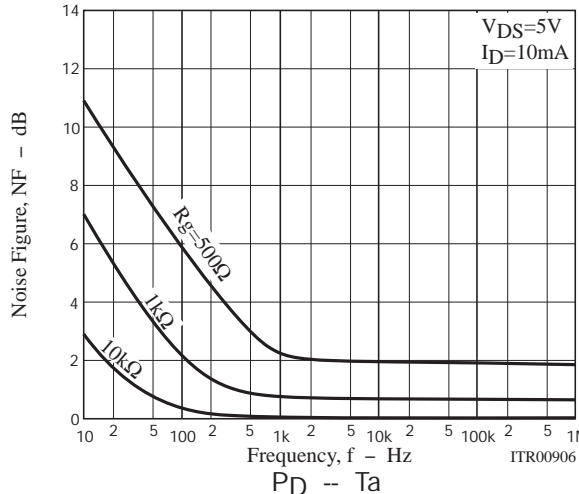
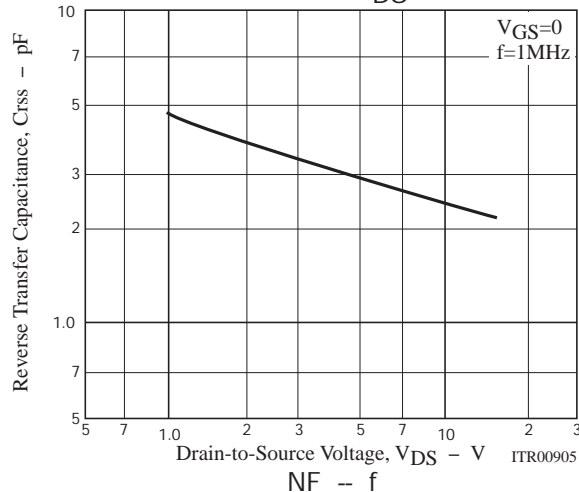
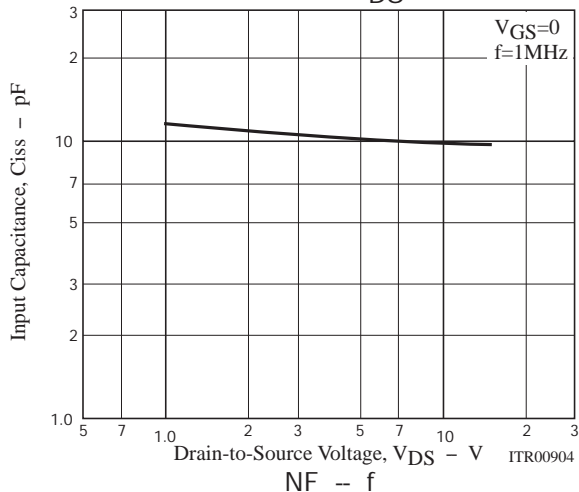
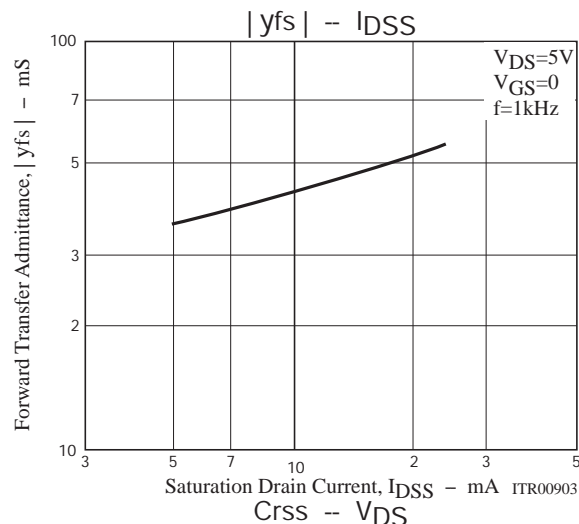
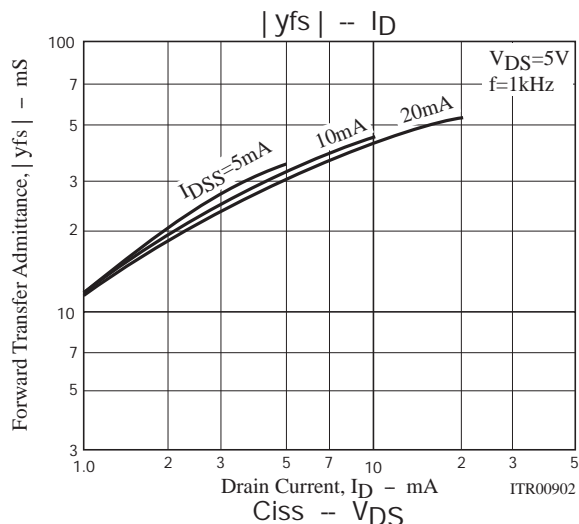
* : The 2SK932 is classified by I_{DSS} as follows : (unit : mA)

Rank	21	22	23	24
I _{DSS}	5.0 to 8.5	7.3 to 12.0	10.0 to 17.0	14.5 to 24.0

Ordering Information

Device	Package	Shipping	memo
2SK932-22-TB-E	CP	3,000pcs./reel	Pb Free
2SK932-23-TB-E	CP	3,000pcs./reel	
2SK932-24-TB-E	CP	3,000pcs./reel	





Embossed Taping Specification

2SK932-22-TB-E, 2SK932-23-TB-E, 2SK932-24-TB-E

1. Packing Format

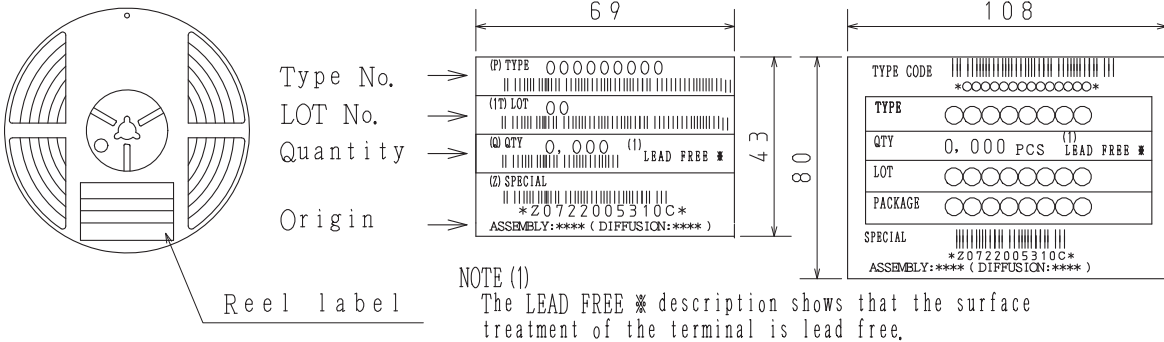
Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
CP	CP	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Reel label, Inner box label
(unit:mm)

Outer box label

It is a label at the time of factory shipments.
The form of a label may change in physical
distribution process.

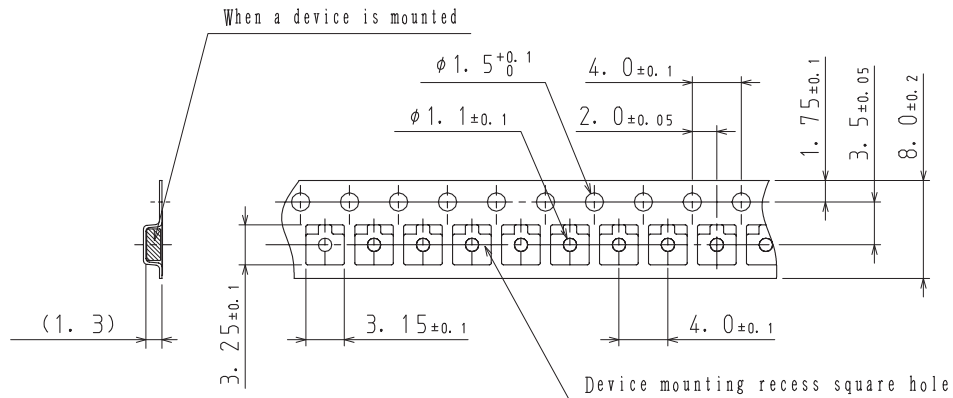
Packing method



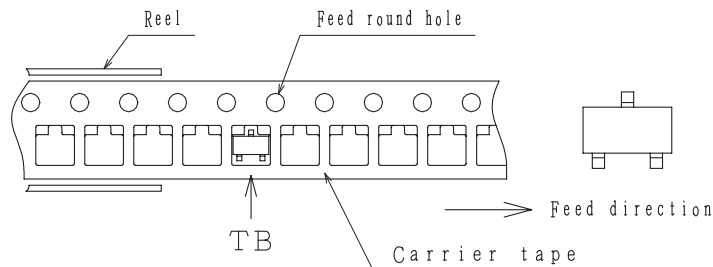
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



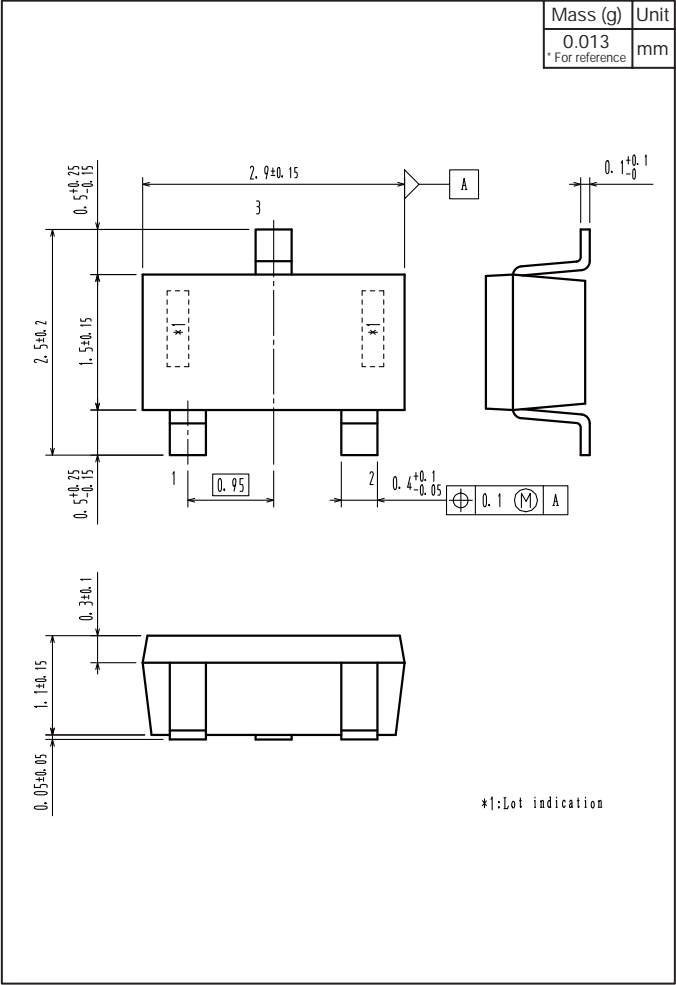
2-2. Device placement direction



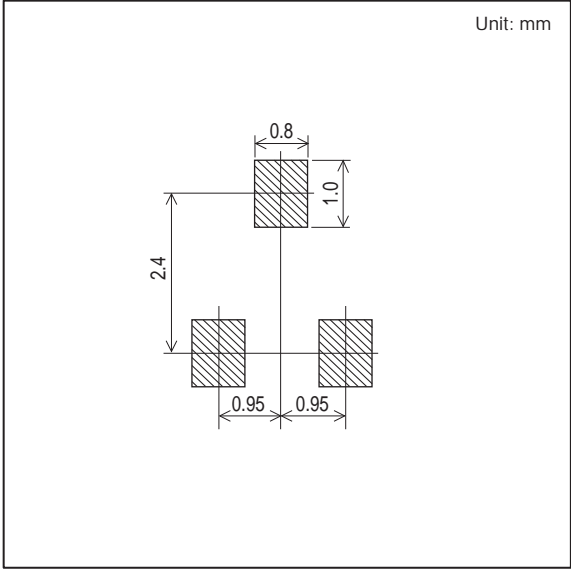
Those with one electrode terminal on the feed hole side.....TB

Outline Drawing

2SK932-22-TB-E, 2SK932-23-TB-E, 2SK932-24-TB-E



Land Pattern Example



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